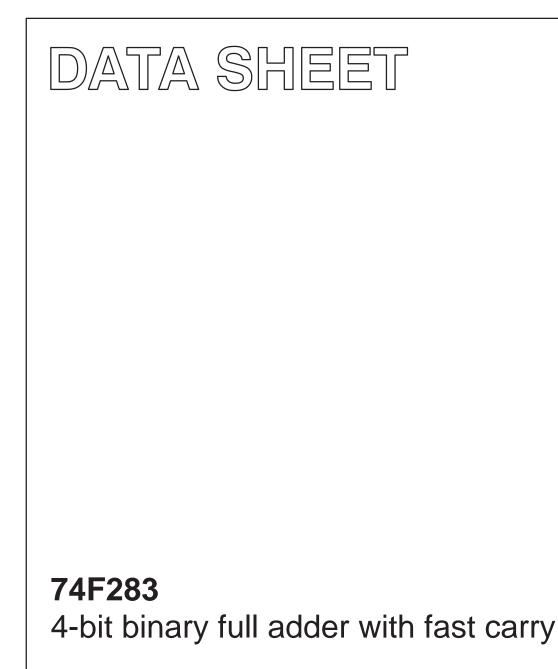
## INTEGRATED CIRCUITS



Product specification

IC15 Data Handbook

1989 Mar 03

Philips Semiconductors

74F283

## 4-bit binary full adder with fast carry

## FEATURES

- High speed 4-bit addition
- Cascadable in 4-bit increments
- Fast Internal carry look-ahead

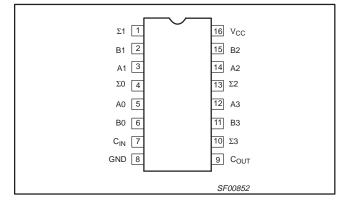
### DESCRIPTION

The 74F283 adds two 4-bit binary words (An plus Bn) plus the incoming carry. The binary sum appears on the sum outputs  $(\Sigma 0-\Sigma 3)$  and the outgoing carry  $(C_{OUT})$  according to the equation:  $C_{IN}+2^0(A0+B0)+2^1(A1+B1)+2^2(A2+B2)+2^3(A3+B3) = \Sigma 0+2\Sigma 1+4\Sigma 2+8\Sigma 3+16C_{OUT}$  where (+)=plus

Due to the symmetry of the binary add function, the 74F283 can be used with either all active-High operands (positive logic) or with all active-Low operands (negative logic). See Function Table. In case of all active-Low operands (negative logic) the results  $\Sigma 1-\Sigma 4$  and  $C_{OUT}$  should be interpreted also as active-Low. With active-High inputs,  $C_{IN}$  cannot be left open; it must be held Low when no "carry in" is intended. Interchanging inputs of equal weight does not affect the operation, thus A0, B0,  $C_{IN}$  can arbitrarily be assigned to pins 5, 6, 7, etc.

Due to pin limitations, the intermediate carries of the 74F283 are not brought out for use as inputs or outputs. However, other means can be used to effectively insert a carry into, or bring a carry out from, an intermediate stage.

### PIN CONFIGURATION



TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F283	6.5ns	40mA

### **ORDERING INFORMATION**

DESCRIPTION	$\begin{array}{l} \text{COMMERCIAL RANGE} \\ \text{V}_{CC} = 5\text{V} \pm 10\%, \\ \text{T}_{amb} = 0^{\circ}\text{C to } + 70^{\circ}\text{C} \end{array}$	PKG DWG #
16-pin plastic DIP	N74F283N	SOT38-4
16-pin plastic SO	N74F283D	SOT109-1

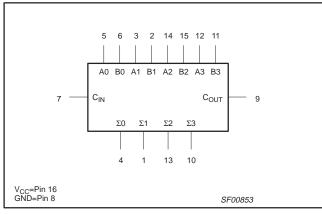
### INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION 74F(U.L.) HIGH/LOW		LOAD VALUE HIGH/LOW
A0 - A3	A operand inputs	1.0/2.0	20µA/1.2mA
B0 - B3	B operand inputs	1.0/2.0	20µA/1.2mA
C <sub>IN</sub>	Carry input	1.0/1.0	20µA/0.6mA
C <sub>OUT</sub>	Carry output	50/33	1.0mA/20mA
Σ0–Σ3	Sum outputs	50/33	1.0mA/20mA

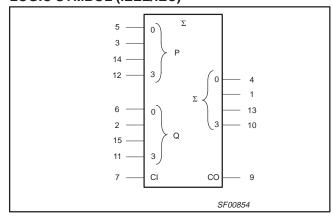
#### NOTE:

One (1.0) FAST Unit Load is defined as: 20µA in the High state and 0.6mA in the Low state.

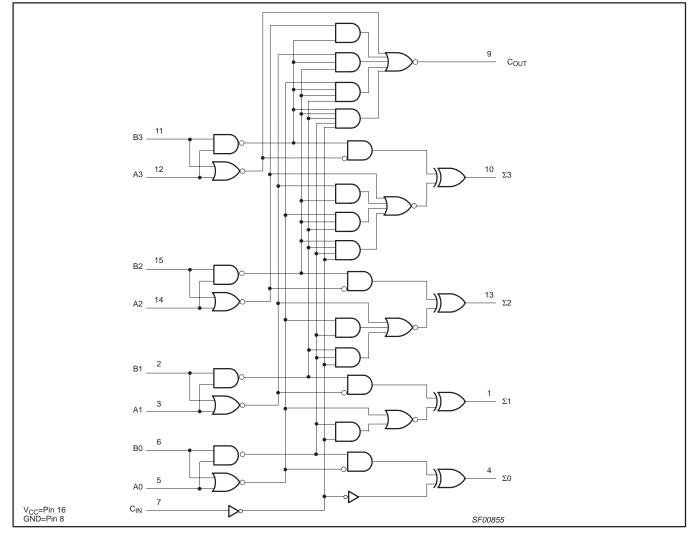
### LOGIC SYMBOL



## LOGIC SYMBOL (IEEE/IEC)



## LOGIC DIAGRAM



## **FUNCTION TABLE**

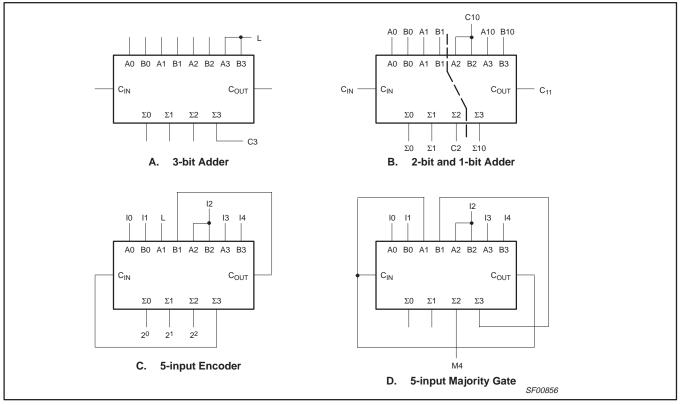
PINS	C <sub>IN</sub>	A0	A1	A2	A3	B0	B1	B2	B3	Σ0	Σ1	Σ2	Σ <b>3</b>	C <sub>OUT</sub>	Example:
Logic levels	L	L	Н	L	Н	Н	L	L	Н	Н	Н	L	L	Н	1001 1010
Active High	0	0	1	0	1	1	0	0	1	1	1	0	0	1	10011 (10+9=19)
Active Low	1	1	0	1	0	0	1	1	0	0	0	1	1	0	(carry+5+6=12)

H = High voltage level L = Low voltage level

Product specification

Figure A shows how to make a 3-bit adder. Tying the operand inputs of the fourth adder (A3, B3) Low makes  $\Sigma$ 3 dependent only on, and equal to, the carry from the third adder. Using somewhat the same principle, Figure B shows a way of dividing the 74F283 into a 2-bit and a 1-bit adder. The third stage adder (A2, B2,  $\Sigma$ 2) is used as means of getting a carry (C10) signal into the fourth stage adder (via A2 and B2) and bringing out the carry from the second stage on  $\Sigma$ 2. Note that as long as A2 and B2 are the same, whether High or Low, they do not influence  $\Sigma 2$ . Similarly, when A2 and B2 are the same, the carry into the third stage does not influence the carry out of the third stage. Figure C shows a method of implementing a 5-input encoder where the inputs are equally weighted. The outputs  $\Sigma 0$ ,  $\Sigma 1$ and  $\Sigma 2$  present a binary number of inputs I0–I4 that are true. Figure D shows one method of implementing a 5-input majority gate. When three or more of the inputs I0–I4 are true, the output M4 is true.

### **APPLICATIONS**



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## 74F283

74F283

### **ABSOLUTE MAXIMUM RATINGS**

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V <sub>CC</sub>	Supply voltage	–0.5 to +7.0	V
V <sub>IN</sub>	Input voltage	–0.5 to +7.0	V
I <sub>IN</sub>	Input current	-30 to +5	mA
V <sub>OUT</sub>	Voltage applied to output in High output state	–0.5 to $V_{CC}$	V
I <sub>OUT</sub>	Current applied to output in Low output state	40	mA
T <sub>amb</sub>	Operating free-air temperature range	0 to +70	°C
T <sub>stg</sub>	Storage temperature	-65 to +150	°C

### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER		UNIT		
STWBOL	PARAMEIER	Min	Nom	Max	UNIT
V <sub>CC</sub>	Supply voltage	4.5	5.0	5.5	V
V <sub>IH</sub>	High-level input voltage	2.0			V
V <sub>IL</sub>	Low-level input voltage			0.8	V
I <sub>IK</sub>	Input clamp current			-18	mA
I <sub>OH</sub>	High-level output current			-1	mA
I <sub>OL</sub>	Low-level output current			20	mA
T <sub>amb</sub>	Operating free-air temperature range	0		70	°C

### **DC ELECTRICAL CHARACTERISTICS**

(Over recommended operating free-air temperature range unless otherwise noted.)

				TEST CONDITIONS <sup>NO TAG</sup>				
SYMBOL	PARAME	TER	TEST CONDITIONS				MAX	UNIT
M			$V_{CC} = MIN, V_{IL} = MAX$	±10%V <sub>CC</sub>	2.5			V
V <sub>OH</sub>	OH High-level output voltage		$V_{IH} = MIN, I_{OH} = MAX$	±5%V <sub>CC</sub>	2.7	3.4		v
M	Low-level output voltage		$V_{CC} = MIN, V_{IL} = MAX$	±10%V <sub>CC</sub>		0.30	0.50	V
V <sub>OL</sub>			$V_{IH} = MIN, I_{OL} = MAX$	±5%V <sub>CC</sub>		0.30	0.50	V
V <sub>IK</sub>	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$	$V_{CC} = MIN, I_I = I_{IK}$			-1.2	V
l <sub>l</sub>	Input current at maximur	n input voltage	$V_{CC} = MAX, V_I = 7.0V$				100	μΑ
I <sub>IH</sub>	High-level input current		$V_{CC} = MAX, V_I = 2.7V$				20	μΑ
		C <sub>IN</sub> only					-0.6	mA
	Low-level input current	An, Bn	$v_{\rm CC} = MAX, v_{\rm I} = 0.5v$	$V_{CC} = MAX, V_I = 0.5V$			-1.2	mA
I <sub>OS</sub>	Short-circuit output current <sup>NO TAG</sup>		V <sub>CC</sub> = MAX		-60		-150	mA
I <sub>CC</sub>	Supply current (total) <sup>4</sup>		$V_{CC} = MAX$			40	55	mA

NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

2. All typical values are at  $V_{CC} = 5V$ ,  $T_{amb} = 25^{\circ}C$ .

4. I<sub>CC</sub> should be measured with all outputs open and the following conditions:

Condition1: all inputs grounded

Condition 2: all B inputs Low, other inputs at 4.5V Condition 3: all inputs at 4.5V

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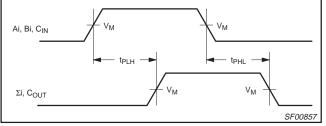
Not more than one output should be shorted at a time. For testing IOS, the use of high-speed test apparatus and/or sample-and-hold 3. techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I<sub>OS</sub> tests should be performed last.

### **AC ELECTRICAL CHARACTERISTICS**

SYMBOL	PARAMETER	TEST CONDITIONS		T <sub>amb</sub> = +25°C V <sub>CC</sub> = +5.V C <sub>L</sub> = 50pF, R <sub>L</sub> = 500Ω	;	C <sub>L</sub> =	C to +70°C .V ± 10% 50pF, 500Ω	UNIT
			MIN	TYP	MAX	MIN	MAX	1
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay $C_{IN}$ to $\Sigma_{I}$	Waveform 1, 2	3.5 4.0	7.0 7.0	9.5 9.5	3.0 3.5	10.5 10.5	ns ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay Ai or Bi to Σi	Waveform 1, 2	3.5 3.5	7.0 7.0	9.5 9.5	2.5 3.5	10.5 10.5	ns ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay C <sub>IN</sub> to C <sub>OUT</sub>	Waveform 2	3.5 3.0	5.7 5.4	7.5 7.0	3.5 2.5	8.5 8.0	ns ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay Ai or Bi to C <sub>OUT</sub>	Waveform 1, 2	3.5 2.5	5.7 5.3	7.5 7.0	3.0 2.5	8.5 8.0	ns ns

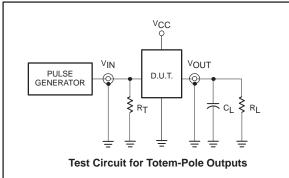
### AC WAVEFORMS

For all waveforms, V<sub>M</sub>=1.5V.



Waveform 1. Propagation Delay Operands and Carry Inputs to Outputs

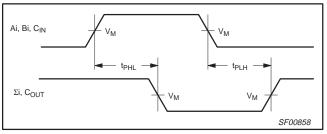
### **TEST CIRCUIT AND WAVEFORM**



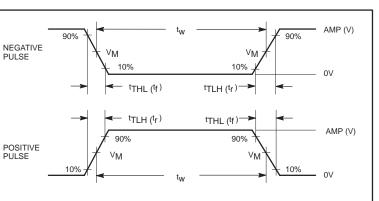
#### **DEFINITIONS:**

R<sub>L</sub> = Load resistor;

- See AC ELECTRICAL CHARACTERISTICS for value. C<sub>L</sub> = Load capacitance includes jig and probe capacitance; see AC ELECTRICAL CHARACTERISTICS for value.
- $R_T$  = Termination resistance should be equal to  $Z_{OUT}$  of pulse generators.



Waveform 2. Propagation Delay Operands and Carry Inputs to Outputs

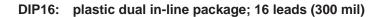


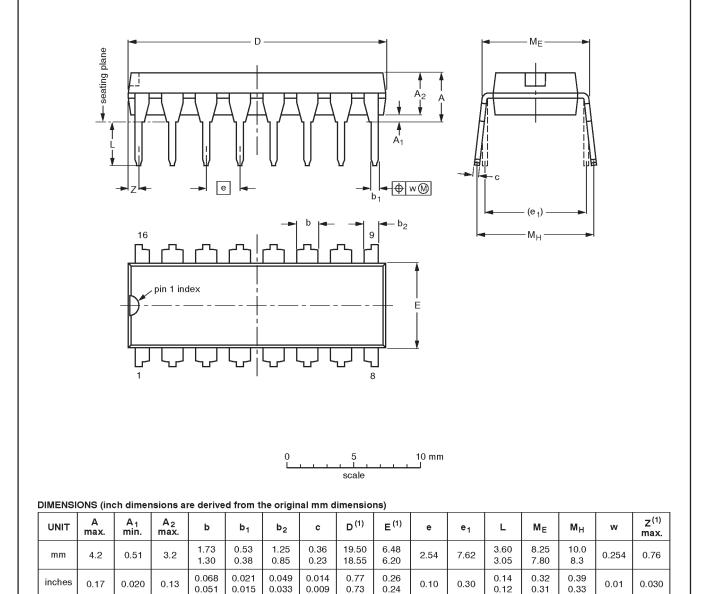
### Input Pulse Definition

fomily	INP	UT PU	LSE REQU	IREMEN	тѕ	
family	amplitude	V <sub>M</sub>	rep. rate	tw	t <sub>TLH</sub>	t <sub>THL</sub>
74F	3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns

SF00006

74F283





#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES			
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT38-4					<del>-92-11-17</del> 95-01-14	

#### Product specification

74F283

#### plastic small outline package; 16 leads; body width 3.9 mm SOT109-1 SO16: А D Х = v 🕅 A 16 Q A<sub>2</sub> $(A_3)$ А pin 1 index p ╫ H Н 8 е + + M detail X bp 0 2.5 5 mm scale DIMENSIONS (inch dimensions are derived from the original mm dimensions) Α E<sup>(1)</sup> Z<sup>(1)</sup> D<sup>(1)</sup> ${\rm H}_{\rm E}$ UNIT $\mathsf{A}_1$ $A_2$ $A_3$ bp С L Lp Q θ е v w У max. 0.7 0.25 1.45 0.49 0.25 10.0 4.0 6.2 1.0 0.7 1.27 1.05 mm 1.75 0.25 0.25 0.25 0.1 8° 0.10 1.25 0.36 0.19 9.8 3.8 5.8 0.4 0.6 0.3 00 0.028 0.010 0.057 0.019 0.0100 0.39 0.16 0.244 0.039 0.028 0.050 0.041 0.01 inches 0.069 0.01 0.01 0.004 0.004 0.049 0.014 0.0075 0.38 0.15 0.228 0.016 0.020 0.012 Note 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included. REFERENCES OUTLINE EUROPEAN **ISSUE DATE** PROJECTION VERSION IEC JEDEC EIAJ 95-01-23 SOT109-1 076E07S MS-012AC $\odot$ E

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NOTES

## 74F283

#### Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
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